

# Switched Capacitor Voltage Converter with Regulated Output

ADP3603

#### **FEATURES**

Fully Regulated Output High Output Current: 50 mA

120 mA Version (ADP3604) Is Also Available Outstanding Precision: ±3% Output Accuracy

Input Voltage Range: +4.5 V to +6.0 V Output Voltage: -3.0 V (Regulated)

High Switching Frequency: 120 kHz (240 kHz Internal

Oscillator)

Shutdown Capability

Small Outline 8-Pin SQIC Package

APPLICATIONS

Voltage Inverters

Negative Voltage Regulators Computer Peripherals and Add On Caxds

Portable Instruments

Battery Powered Devices

Pagers and Radio Control Receivers

Disk Drives Mobile Phones

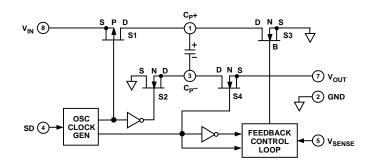
#### GENERAL DESCRIPTION

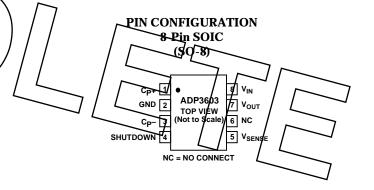
The ADP3603 switched capacitor voltage converter provides a regulated output voltage with minimum voltage loss and requires a minimum number of external components. In addition, the ADP3603 does not require the use of an inductor. The ADP3603 provides up to 50 mA of output current with  $\pm 3\%$  output accuracy.

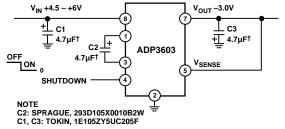
The internal oscillator runs at 240 kHz nominal frequency which produces an output switching frequency of 120 kHz, allowing the use of small charge pump and filter capacitors. The ADP3603 is primarily designed for use as a high frequency negative voltage regulator/inverter. The output voltages of the ADP3603 can range from -1.2 V to -4.0 V, nominally -3.0 V. For other output voltages, contact the factory.

The ADP3603 dissipates less than 150 mW of power and features fast shutdown mode capability (<5 ms) that also drops the quiescent current to 1.4 mA (typ). For a higher output current (120 mA) version, see the ADP3604.

#### FUNCTIONAL BLOCK DIAGRAM







†FOR BEST PERFORMANCE 10µF IS RECOMMENDED

Figure 1. Typical Application Circuit

## ADP3603—SPECIFICATIONS ( $V_{IN} = 5.0 \text{ V} @ T_A = +25^{\circ}\text{C}$ , $C_P = C_{OUT} = 10 \mu\text{F}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Units
OPERATING SUPPLY RANGE	V <sub>S</sub>		4.5	5	6	V
SUPPLY CURRENT	$I_{S}$			2.4	3	mA
		$-40^{\circ} \text{C} < \text{T}_{\text{A}} < +85^{\circ} \text{C}$		2.5	3.5	mA
Shutdown Mode				1.4	2	mA
		$-40^{\circ} \text{C} < \text{T}_{\text{A}} < +85^{\circ} \text{C}$		1.5	2.5	mA
OUTPUT						
Output Voltage	$V_{O}$	$I_{\rm O} = 25 \text{ mA}$	-3.1	-3	-2.91	V
- mf m	$\mathbf{v}_{o}$	$I_{O} = 10 \text{ mA} \text{ to } 50 \text{ mA}, 4.5 \text{ V} < V_{IN} < 6 \text{ V}$	-3.1	-3	-2.9	V
	Vo	$I_O = 10 \text{ mA} \text{ to } 50 \text{ mA}, 4.5 \text{ V} < V_{IN} < 6 \text{ V},$				
	1.0	$0^{\circ}C < T_{A} < +70^{\circ}C$	-3.12	-3	-2.88	V
	$V_{O}$	$I_{O} = 10 \text{ mA}$ to 50 mA, 4.5 V < $V_{IN}$ < 6 V,				
	1.0	$-40^{\circ}\text{C} < \text{T}_{\text{A}} < +85^{\circ}\text{C}$	-3.15	-3	-2.85	V
Load Regulation	$\Delta V_{\rm O}/I_{\rm O}$	$I_O = 10 \text{ mA} - 60 \text{ mA}$	3.23	0.9		mV/mA
		$I_{\rm O} = 10 \text{ mA} - 120 \text{ mA}$		1.5		mV/mA
Output Resistance <sup>2</sup>	$R_{O}$			8		Ω
Output Ripple Voltage <sup>3</sup>	$V_{RIPPLE}$	$C1-C3 = 10 \mu F$ , $I_{LOAD} = 80 \text{ mA}$		25		mV
	· KIITLE	$I_{LOAD} = 120 \text{ mA}$		55		mV
SWITCHING FREQUENCY		EOAD	100	100	100	kHz
WITCHING FREQUENCY	月% —	100C . T 000C	100	120	130	
	+	140°C < T <sub>A</sub> +85°C	96	120	140	kHz
SHUTDOWN / [ ) )						
Logic Input High	<b>₩</b>		2.4			V
Input Current	\ I <sup>I</sup> \ )		$\bigcap$	1		μA
Logic Input Low	$V_{IL}$	V		$\supset$ $\sim$	0.4	V
Input Current	I <sub>IL</sub>	$1 \setminus \bigcup J \setminus I \cap I$	1/ -	J [_ `		μA
Turn-On-Time	$t_{ON}$	Figure 1, $I_L = 120 \text{ mA}$		, 5 7	$\sim$ $I$	Tms
Turn-Off-Time	$t_{ m OFF}$	Figure $1, I_L = 120 \text{ mA}$		5	/ 7/	ms_
NOTES			1	-	1 1	<del>'                                    </del>
	are 10 $\mu F$ with 0.1	$\Omega$ ESR. Capacitors with higher ESR may reduce output	voltage and eff	iciency.	/ /	
Open-loop output resistance.			/		/	
See Figure 1 conditions.	1 1 . 0		1.	<u> </u>	- 1	/ _
All limits at temperature extremes are guarant Specifications subject to change without notice		sing standard Statistical Quality Control (SQC) method		~	L	
specifications subject to change without notice	÷.		PIN DESC	RIPTION	_	~ 7

#### ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

 $(T_A = +25^{\circ}C \text{ unless otherwise noted})$ 

Input Voltage (V+ to GND, GND to OUT)+7.5 V
Output Short Circuit Protection1 sec
Power Dissipation, SO-8
$\theta_{JA}^2$
$\theta_{JC}$
Operating Temperature Range40°C to +85°C
Storage Temperature Range65°C to +150°C
Lead Temperature Range (Soldering 10 sec) +300°C
Vapor Phase (60 sec) +215°C
Infrared (15 sec) +220°C
NOTEC

<sup>1</sup>This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

 $^{2}\theta_{JA}$  is specified for worst case conditions with device soldered on a circuit board.

#### **ORDERING GUIDE**

Model	Temperature Range	Package Option*
ADP3603AR	-40°C to +85°C	SO-8

<sup>\*</sup>SO = Small Outline Package.

Pin	Function	

- 1 C<sub>P</sub>+, Pump Capacitor Positive Input.
  - Ground.

2

- 3 C<sub>P</sub>-, Pump Capacitor Negative Input.
- 4 Shutdown, Logic Level Shutdown Pin. Application of a logic low to this pin will place the regulator in normal operation. The device will be put into shutdown mode with the shutdown pin pulled to V<sub>IN</sub>. In Shutdown mode the charge pump is turned off. Connect to ground for normal operation.
- 5  $V_{SENSE}$ , Output Voltage Sense Line. This is used to improve load regulation performance by eliminating IR drop on the output traces. See application section for more detail. For normal operation, connect Pin 5 to  $V_{OUT}$  (Pin 7).
- 6 NC, No Internal Electrical Connection.
- 7 V<sub>OUT.</sub> Output Pin. Regulated negative output voltage. Connect a low ESR capacitor between this pin and de-8
  - $V_{IN}$ , Positive Supply Input when 4.5 V  $\leq$   $V_{IN} \leq$  6 V. Connect a low-ESR bypass capacitor between this pin and the device ground pin.

#### **CAUTION**

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADP3603 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



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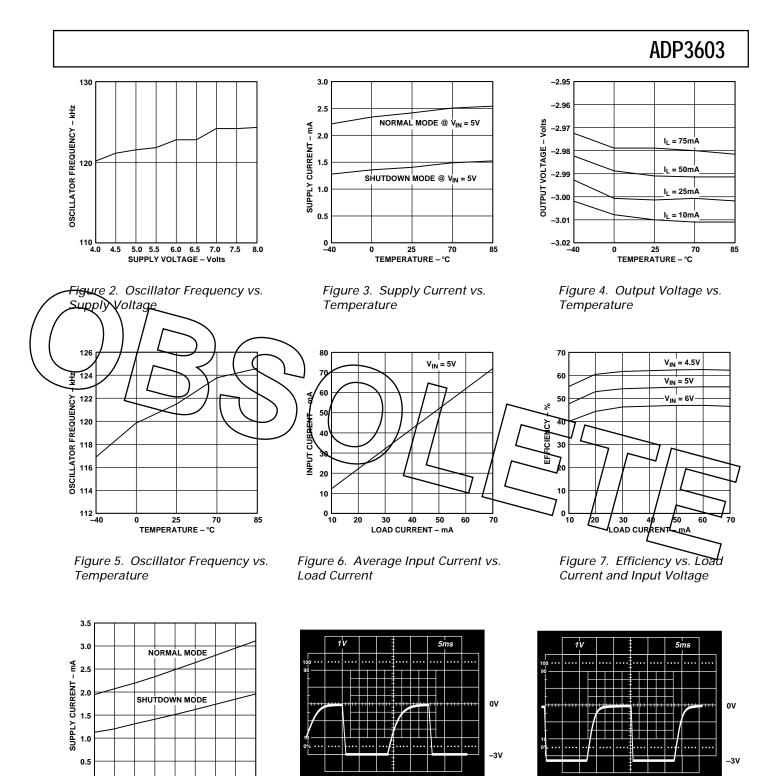


Figure 8. Supply Current vs. Supply Voltage

4.5 5.0 5.5 6.0 6.5 7.0 7.5 8.0 SUPPLY VOLTAGE – Volts

Figure 9. Start-Up Under Full Load

Figure 10. Enable/Disable Time Under Full Load

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#### ADP3603

#### APPLICATION INFORMATION

The ADP3603 uses a charge pump to generate a negative output voltage from a positive input supply. To understand the operation of the ADP3603, a review of a basic switch capacitor building block is helpful.

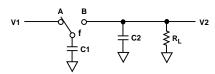


Figure 11. Basic Switch Capacitor Circuit

In Figure 11, when the switch is in the A position, capacitor C1 will be charged to voltage V1. The total charge on C1 will be A = C1V1.

The switch then moves to the B position, discharging C1 to voltage V2. After this discharge time, the charge on C1 is q2 = C1 $\sqrt{2}$ . The amount of charge transferred from the source, V1, to the output, V2, is:  $\Delta q = q1 - q2 = \sqrt{1} (V1 - V2)$ 

If the switch is cycled f times per second, the sharge transfer per unit time (i.e., current) is:  $I = f \Delta q = f C I \ (VI - V2)$ 

To obtain an equivalent resistance for the switched-capacitor network we can rewrite this equation in terms of voltage and impedance equivalence:

$$I = (V1 - V2)/(1/fC1) = (V1 - V2)/R_{EQUIV}$$

where  $R_{EQUIV}$  is defined as:

$$R_{EQUIV} = 1/f C1$$

Figure 11 equivalent circuit can now be drawn as shown in Figure 12.

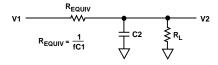


Figure 12. Basic Switch Capacitor Equivalent Circuit

#### THEORY OF OPERATION

A switched capacitor principle is used in the ADP3603 to generate a negative voltage from a positive input voltage. An on-board oscillator generates two phase clocks to control a switching network which transfers charge between the storage capacitors. The basic principle behind the voltage inversion scheme is illustrated in Figures 13 and 14.

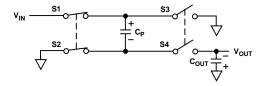


Figure 13. ADP3603 Switch Configuration Charging the Pump Capacitor

During phase one, S1 and S2 are ON charging the pump capacitor to the input voltage. Before the next phase begins, S1

and S2 are turned OFF as well as S3 and S4 to prevent any overlap. S3 and S4 are turned ON during the second phase (see Figure 14) and charge stored in the pump capacitor is transferred to the output capacitor.

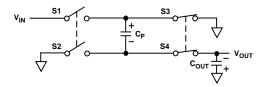


Figure 14. ADP3603 Switch Configuration Charging the Output Capacitor

During the second phase, the positive terminal of the pump capacitor is connected to ground and the negative terminal is connected to the output, resulting in a voltage inversion at the output terminal. Output regulation is done by adjusting the ON resistance of the S3 through the feedback control loop.

The ADP3603 alternately charges  $C_P$  to the input voltage when  $C_P$  is switched in parallel with the input supply, and then transfers charge/to  $C_{OUT}$  when  $C_P$  is switched in parallel with  $C_{OUT}$ . Switching/occurs at 120 kHz rate. During the time that  $C_P$  is charging, the peak current is approximately 2 times the output current. During the time that  $C_P$  is delivering charge to  $C_{OUT}$ , the supply current drops down to about 2/mA. An input supply bypass capacitor will supply part of the peak input current drawn by the ADP3603, and average out the current drawn from the supply. A minimum input supply bypass capacitor of 1  $\mu$ F, preferably a low ESR capacitor such as tantalum or multiplayer ceramic chip capacitor, is recommended. A large capacitor may be desirable in some cases, for example when the input supply is connected to the ADP3603 through long leads, or when the pulse current drawn by the device might effect other circuitry through supply coupling.

The output capacitor,  $C_{OUT}$ , is alternately charged to the  $C_P$  voltage when  $C_P$  is switched in parallel with  $C_{OUT}$ . The ESR of the  $C_{OUT}$  introduces steps in the  $V_{OUT}$  waveform whenever the charge pump charges  $C_{OUT}$ . This tends to increase  $V_{OUT}$  ripple. Ceramic or tantalum capacitors are recommended for  $C_{OUT}$  if minimum ripple is desired. The ADP3603 can operate with a range of capacitors from 1  $\mu F$  to 100  $\mu F$  and larger without any stability problems. However, all tested parameters are obtained using 10  $\mu F$  multilayer ceramic capacitors.

In most applications, IR drops due to printed circuit board traces do not present a problem. In this case,  $V_{\rm SENSE}$  is tied to the output at a convenient pcb location not far from the  $V_{\rm OUT}.$  However, if a reduction in IR drops or improvement in load regulation is desired, the sense line can be used to monitor the output voltage at the load. To avoid excessive noise pickup, the  $V_{\rm SENSE}$  line should be as short as possible and away from any noisy line.

#### **Capacitor Selection**

While the exact values of the  $C_{\rm IN}$  and  $C_{\rm OUT}$  are not critical, good quality, low ESR capacitors such as solid tantalum and multilayer ceramic capacitors are recommended to minimize voltage losses at high currents. For a given load current, factors affecting the output voltage performance are in Figure 15:

- Pump (C2) and the output (C3) capacitance
- ESR of the C2 and C3.

-4- REV. 0

Since output current is supplied solely by the output capacitor C3 during one-half of the charge-pump cycle, peak-to-peak output ripple voltage is calculated by using the following formula:

$$V_{RIPPLE} = \frac{I_{OUT}}{2(F_{PUMP})(C2)} + I_{OUT}(ESR_{C2})$$

In Figure 15, output ripple voltage vs. capacitance and various ESR are shown.

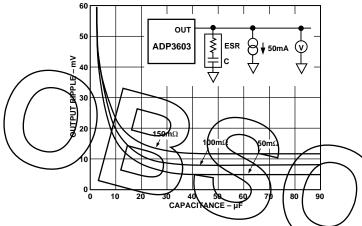


Figure 15. Output Ripple Voltage (mV) vs. Capacitance and ESR

Note that as the capacitor value increases beyond the point where the dominant contribution to the output ripple is due to the ESR, no significant reduction in  $V_{OUT}$  ripple is achieved by added capacitance.

A low ESR capacitor has much greater impact on performance for C2 than C3 since current through C2 is twice the C3 current. There is a voltage drop across  $C_P{}^{\prime}{}s$  ESR during the charge as well as during discharges. Therefore, the voltage drop due to C2 is about 4 times C2's ESR times the load current. The voltage drop generated by C2's ESR combined with the voltage drop due to the output source resistance, determines the maximum available  $V_{OUT}{},$  while C3's ESR affects the output voltage ripple.

When selecting the capacitors, keep in mind that not all manufacturers guarantee capacitor ESR in the range required by the circuit. In general, the capacitor's ESR is inversely proportional to its physical size, so larger capacitance values and higher voltage ratings tend to reduce ESR.

ESR is also a function of the operating frequency. When selecting a capacitor, make sure its value is rated at the circuit's operating frequency. The other factor affecting the capacitor's performance is temperature. If the circuit has to operate at temperatures significantly different than 25°C, the capacitance and ESR values must be carefully selected to adequately compensate for the change. Various capacitor technologies offer improved performance over temperature, for example, certain tantalum capacitors provide good low-temperature ESR but at a higher cost.

Figure 16 demonstrates the effect temperature has on various capacitors. ADP3603's high internal oscillator frequency permits the usage of smaller capacitance for both the pump and the output capacitors.

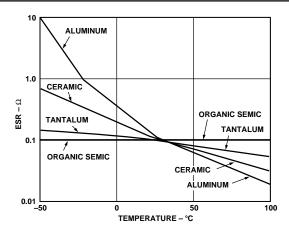


Figure 16. ESR vs. Temperature

**Table I. Alternative Capacitor Technologies** 

Туре	Life	High Frequency	Temp	Size	Cost
Aluminum Electrolytic Capacitor	Fair	Fair	Fair	Small	Low
Multilayer Ceramic Capacitor	Long	Good	Poor	Fair	High
Solid Tantalum Capacitor	Above Avg	Ayg	/Avg /	Avg	Ayvg
OS-CON Capacitor	Above Avg	Good	Good	Good	Avg

Table II shows a partial list of manufacturers providing low-ESR capacitors.

**Table II. Recommended Capacitor Manufacturers** 

Manufacturer	Capacitor	Capacitor Type
Sprague	672D, 673D, 674D, 678D	Aluminum Electrolytic
Sprague	675D, 173D, 199D	Tantalum
Nichicon	PF & PL	Aluminum Electrolytic
Mallory	TDC & TDL	Tantalum
TOKIŇ	MLCC	Multilayer Ceramic
muRata	GRM	Multilayer Ceramic

#### EXTERNAL OUTPUT FILTERING

In applications requiring very low power supply ripple and noise, the circuit in Figure 17 provides low noise and ripple of less than 2% of the output voltage over the full load current and temperature.

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### ADP3603

The output current is supplied solely by the output capacitor C3 during one-half of the charge-pump cycle. This introduces a peak-to-peak ripple of:

$$V_{RIPPLE} = \frac{I_L}{2 \times 120 \ kHz \times C3} + I_L \times ESR_{C3}$$

For a nominal F pump of 120 kHz (one-half the nominal 240 kHz oscillator frequency) and C3 = 10  $\mu F$  with an ESR of 0.15  $\Omega,$  ripple voltage is approximately 30 mV with a 50 mA load current.

Multilayer Ceramic Capacitors (MLCC) offer great performance and small size. Using multiple capacitors connected in parallel yields lower ESR and a potential saving in cost. Lighter loads require proportionally smaller capacitors. To reduce high frequency noise, bypass the output with a  $0.1\,\mu\text{F}$  ceramic

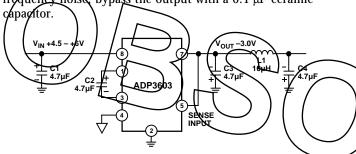


Figure 17. Circuit with Improved Output Ripple & Noise Voltage

**Table III. Recommended Components for Circuit in Figure 17** 

Component	Manufacturer/Type	
C2	Sprague, 293D475X0035D2W	
C1, C3, C4	TOKIN, 1E475ZY5U-C205-F	
L1	Coiltronics, CTX32CT	

#### EXTERNAL INPUT FILTERING

If the ADP3603 is supplied from a high-impedance source, connect an additional bypass capacitor from V+ to ground. Low-ESR capacitors of up to  $100~\mu F$  give best results. Place external capacitors close to the supply pins of the device with the ground connection made as close to the device ground as possible. The same ground point should be used for the output bypass capacitor.

Smaller bypass capacitors can be used in conjunction with a  $\pi$ -LC filter.

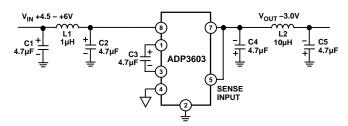


Figure 18. Circuit with Reduced Input and Output Ripple & Noise Voltage

**Table IV. Recommended Components for Circuit in Figure 18** 

Component	Manufacturer/Type	
C3	Sprague, 293D475X0035D2W	
C1, C2, C4, C5	TOKIN, 1E475ZY5UC205F	
L1	Coiltronics, CTX32CT-1R0	
L2	Coiltronics, CTX32CT-100	

#### SHUTDOWN MODE

ADP3603's output can be turned off by utilizing the shutdown pin, Pin 4. Pulling the shutdown pin high to a TTL/CMOS logic compatible level will stop the internal oscillator and turn OFF the output pass transistor. A digital low level will turn the output ON. If the shutdown feature of the device is not used, Pin 4 should be tied to the ground pin of the device.

#### MAXIMUM OUTPUT VOLTAGE

Maximum unregulated output voltage can be obtained by connecting the sense pin to ground instead of the  $V_{\rm OUT}$  pin as shown in Figure 19.

Under this condition, the magnitude of the unregulated output voltage depends on the load current. V<sub>OUT</sub> is inversely proportional to the load current as shown on the graph in Figure 19.

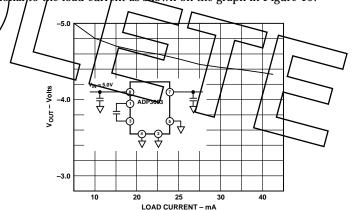


Figure 19. Maximum Unregulated Output Voltage

Under light loads, 30 mA <  $I_{LOAD},$  a regulated output voltage between -3.0~V to  $-V_{\rm IN}~V$  is possible by inserting a resistor between the sense pin and the  $V_{\rm OUT}$  pin as shown in Figure 20. The output voltage is approximated using the following formula:

$$V_{OUT} = -(3 + R/5)$$

where  $V_{OUT}$  is in volts and R is in k $\Omega$ s.

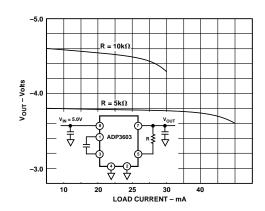


Figure 20. Maximum Regulated Output Voltage

#### POWER DISSIPATION

The power dissipation of the ADP3603 circuit must be limited such that the junction temperature of the device does not exceed the maximum junction temperature rating.

Power is dissipated in two components, power loss due to voltage drops in the switches, and power loss due to MOSFET drive current losses. Total power dissipation is calculated:

$$P \approx (V_{IN} - |V_{OUT}|)(I_{OUT}) + (V_{IN})(I_{S})$$

where both  $V_{IN}$  and  $V_{OUT}$  are referred to ground pin of the ADP3603.

For example: Assuming the worst case conditions,  $V_{\rm IN}$  = 5.5 V,  $V_{\rm OUT}$  = -2.85 V, and  $I_{\rm OUT}$  = 50 mA, calculated power dissipation is:

 $P \approx (5.5 \text{ V} - | -2.85 \text{ V}|) (0.05 \text{ A}) + (5.5 \text{ V}) (0.003 \text{ A}) = 149 \text{ mW}$ This is far below the power dissipation capability of the ADP3603 package which is 660 mW.

LAYOUT AND GROUNDING TIPS

The ADP 3603 switches turn on and off very fast. Good PC board layout practices will ensure the proper operation of the device. Important layout considerations include:

Use adequate ground and power traces or planes

Keep components as close as possible to the device

Use short trace lengths from the input and output capacitors to the input and output pins respectively.

Use single point ground for the device ground pins and the input and output capacitors.

Improper layouts will result in poor load regulation, especially with heavy loads.

#### **APPLICATIONS**

#### **ADP3603 Evaluation Board Layout**

The ADP3603 evaluation board is a general purpose circuit board. Its flexible design allows the user to optimize the circuit performance by external components selection and circuit configuration. The circuit board can be configured as a basic charge pump voltage inverter with one pump capacitor and two bypass capacitors or as a more complex circuit with input and output LC filters.

PC layout is designed for surface mount components and can be easily configured for through-hole components as well.

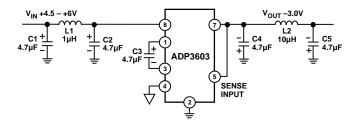
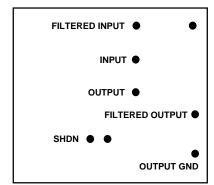


Figure 21. ADP3603 Evaluation Board Circuit Diagram

**Table V. Recommended Components for Circuit in Figure 21** 

Component	Manufacturer/Type	
C3	Sprague, 293D475X0035D2W	
C1, C2, C4, C5	TOKIN, 1E475ZY5UC205F	
L1	Coiltronics, CTX32CT-1R0	
L2	Coiltronics, CTX32CT-100	



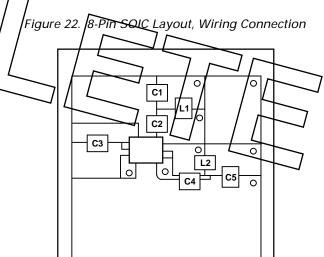


Figure 23. 8-Pin SOIC Layout, Component Placement Diagram (1× Scale)

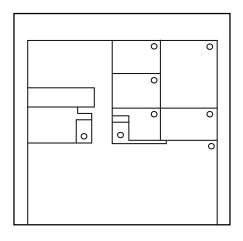


Figure 24. 8 Pin-SOIC Layout, Component Side (1x Layout)

#### **OUTLINE DIMENSIONS**

Dimensions shown in inches and (mm).

#### 8-Pin SOIC (SO-8)

